

## ICE31M120W4 Silicon Carbide Power MOSFET

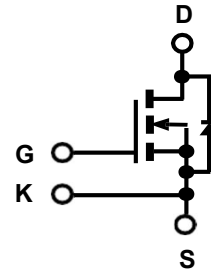
Product Summary			
$I_D$	$T_A=25^\circ\text{C}$	57A	Max
$V_{(BR)DSS}$	$T_C=25^\circ\text{C}$	1200V	Min
$r_{DS(on)}$	$V_{GS}=18\text{V}$	30.4m $\Omega$	Typ
$Q_g$	$V_{DS}=800\text{V}$	63nC	Typ

### Features

- 1200V 30.4mohm SiC MOSFET
- High blocking voltage with low on resistance
- High-speed switching with low capacitances
- Fast Reverse Recovery
- Optimized design for high performance power systems



Lead Free



TO247-4L

1: D, 2: S,  
3: K, 4: G

**Maximum ratings**<sup>a</sup>, at  $T_j=25^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Continuous drain current	$I_D$	$T_c=25^\circ\text{C}$	57	A
		$T_c=100^\circ\text{C}$	40	
Pulsed drain current	$I_{D, \text{pulse}}$		198	A
Maximum gate source voltage	$V_{GS(max)}$		-10/+22	V
Operational gate source voltage	$V_{GS \text{ op}}$		-5/+18	V
Power dissipation	$P_{\text{tot}}$	$T_c=25^\circ\text{C}$	234	W
		$T_c=100^\circ\text{C}$	117	
Storage temperature	$T_{\text{stg}}$		-55 to +150	$^\circ\text{C}$
Operating temperature	$T_j$		-55 to +175	$^\circ\text{C}$

<sup>a</sup> Pulse width limited by  $T_{jmax}$

Parameter	Symbol	Conditions	Values			Unit
			Min	Typ	Max	

### Thermal characteristics

Thermal resistance, junction-case	$R_{thJC}$		-	-	0.64	°C/W
Soldering temperature, wave soldering only allowed at leads	$T_{sold}$	1.6mm (0.063in.) from case for 10 s	-	-	260	°C

### Electrical characteristics<sup>a</sup>, at $T_j=25^{\circ}\text{C}$ , unless otherwise specified

#### Static characteristics

Drain-source breakdown voltage	$V_{(BR)DSS}$	$V_{GS}=0\text{V}, I_D=250\mu\text{A}$	1200	-	-	V
Gate threshold voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=11\text{mA}, T_j=25^{\circ}\text{C}$	2	3.0	4	
		$V_{DS}=V_{GS}, I_D=11\text{mA}, T_j=175^{\circ}\text{C}$	-	2.2	-	
Zero gate voltage drain current	$I_{DSS}$	$V_{DS}=1200\text{V}, V_{GS}=0\text{V}, T_j=25^{\circ}\text{C}$	-	0.1	50	$\mu\text{A}$
		$V_{DS}=1200\text{V}, V_{GS}=0\text{V}, T_j=175^{\circ}\text{C}$	-	1	-	
Gate source leakage current	$I_{GSS}$	$V_{GS}=-10/+22\text{V}, V_{DS}=0\text{V}$	-	-	$\pm 100$	nA
Drain-source on-state resistance	$R_{DS(on)}$	$V_{GS}=18\text{V}, I_D=40\text{A}, T_j=25^{\circ}\text{C}$	-	30.4	40	m $\Omega$
		$V_{GS}=18\text{V}, I_D=40\text{A}, T_j=175^{\circ}\text{C}$	-	54	-	
Gate resistance	$R_G$	$f=1\text{ MHz}, V_{AC}=30\text{mV}$	-	2.4	-	$\Omega$

#### Dynamic characteristics

Input capacitance	$C_{iss}$	$V_{DS}=800\text{V}, V_{GS}=0\text{V}, f=100\text{ kHz}, V_{AC}=30\text{mV}$	-	2338	-	pF
Output capacitance	$C_{oss}$		-	96	-	
Reverse transfer capacitance	$C_{rss}$		-	4.1	-	
$C_{OSS}$ stored energy	$E_{oss}$		-	37	-	$\mu\text{J}$
Forward transconductance	$g_{FS}$	$V_{DS}=20\text{V}, I_D=40\text{A}$	-	28	-	S
Turn-on delay time	$t_{d(on)}$	$V_{DS}=800\text{V}, V_{GS}=-5/+18\text{V}, I_D=40\text{A}, R_G=4.7\Omega$ (External), $T_j=25^{\circ}\text{C}$	-	10	-	ns
Rise time	$t_r$		-	15	-	
Turn-off delay time	$t_{d(off)}$		-	19	-	
Fall time	$t_f$		-	10	-	
Turn-on switching energy	$E_{ON}$		-	293	-	$\mu\text{J}$
Turn-off switching energy	$E_{OFF}$	-	15	-		

Parameter	Symbol	Conditions	Values			Unit
			Min	Typ	Max	

### Dynamic characteristics

Turn-on delay time	$t_{d(on)}$	$V_{DS}=800V, V_{GS}=-5/+18V,$ $I_D=40A, R_G=4.7\Omega$ (External), $T_j=175^\circ C$	-	9	-	ns
Rise time	$t_r$		-	19	-	
Turn-off delay time	$t_{d(off)}$		-	23	-	
Fall time	$t_f$		-	10	-	
Turn-on switching energy	$E_{ON}$		-	456	-	$\mu J$
Turn-off switching energy	$E_{OFF}$		-	15	-	

### Gate Charge Characteristics

Gate to source charge	$Q_{gs}$	$V_{DS}=800V, I_D=40A,$ $V_{GS}=-5$ to $+18V$	-	19	-	nC
Gate to drain charge	$Q_{gd}$		-	21	-	
Gate charge total	$Q_g$		-	63	-	

### Reverse Diode

Continuous forward current	$I_S$	$V_{GS}=-5V$	-	57	-	A
Diode forward voltage	$V_{SD}$	$V_{GS}=-5V, I_{SD}=20A, T_j=25^\circ C$	-	4.0	-	V
		$V_{GS}=-5V, I_{SD}=20A,$ $T_j=175^\circ C$	-	3.5	-	
Reverse recovery time	$t_{rr}$	$V_{GS}=-5V, V_{RR}=800V,$ $I_{SD}=40A,$ $d_{iF}/d_t=10.7$ kA/ $\mu s, T_j=25^\circ C$	-	8	-	ns
Reverse recovery charge	$Q_{rr}$		-	217	-	nC
Peak reverse recovery current	$I_{rm}$		-	42	-	A
Reverse recovery time	$t_{rr}$	$V_{GS}=-5V, V_{RR}=800V,$ $I_{SD}=40A,$ $d_{iF}/d_t=12.6$ kA/ $\mu s,$ $T_j=175^\circ C$	-	15	-	ns
Reverse recovery charge	$Q_{rr}$		-	806	-	nC
Peak reverse recovery current	$I_{rm}$		-	78	-	A

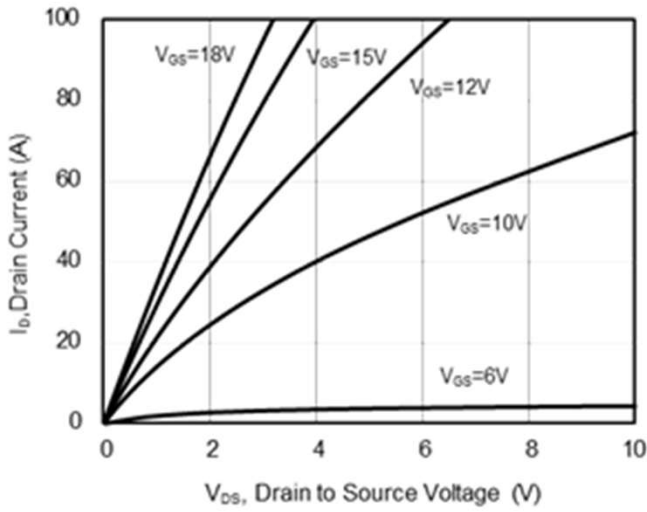


Fig 1. Output Characteristics,  $T_j=25^\circ\text{C}$

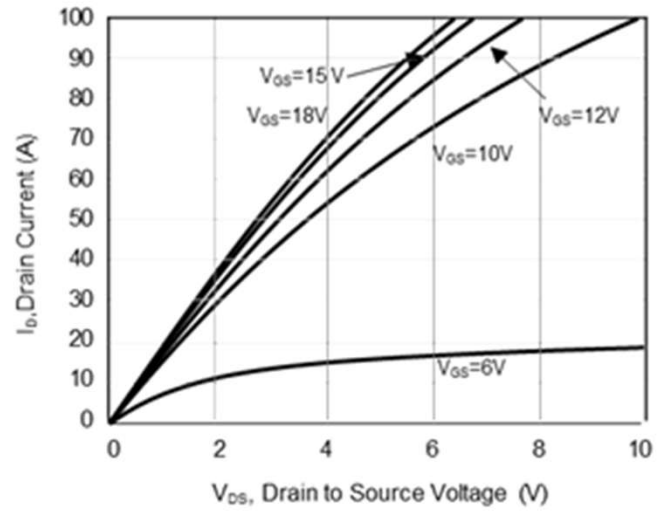


Fig 2. Output Characteristics,  $T_j=175^\circ\text{C}$

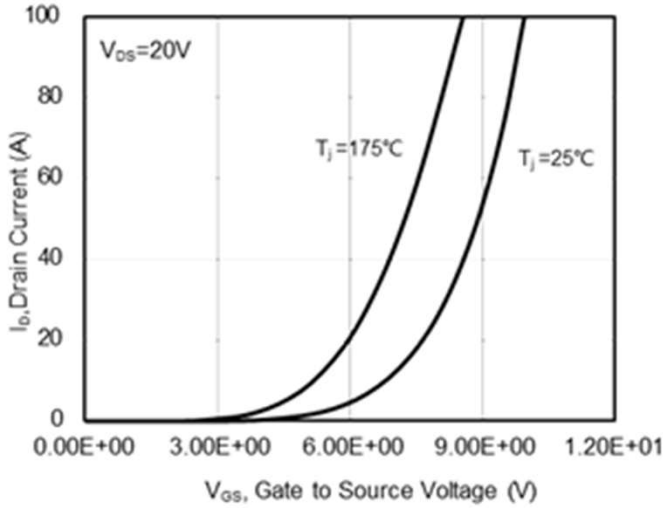


Fig 3. Transfer Characteristics

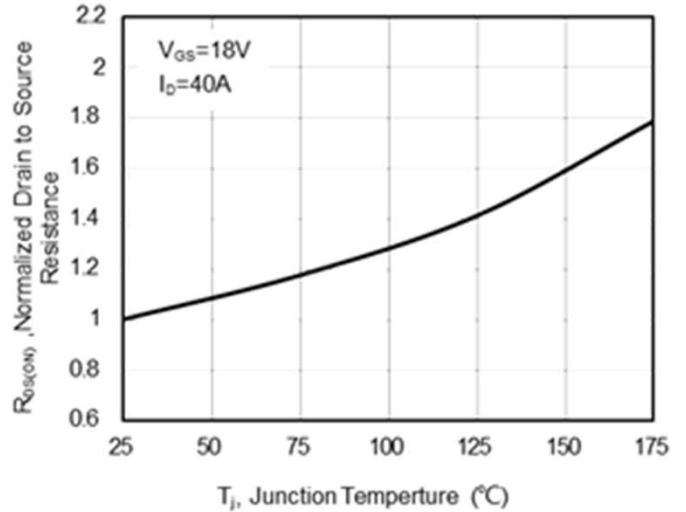


Fig 4. On-Resistance Variation with Temperature

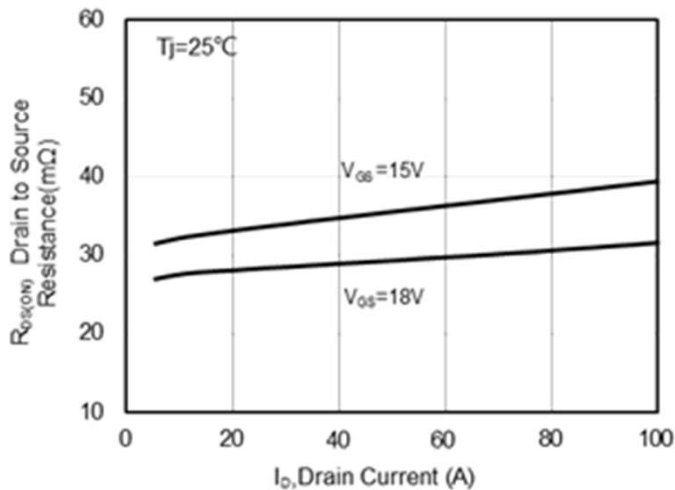


Fig 5. On-Resistance vs Drain Current

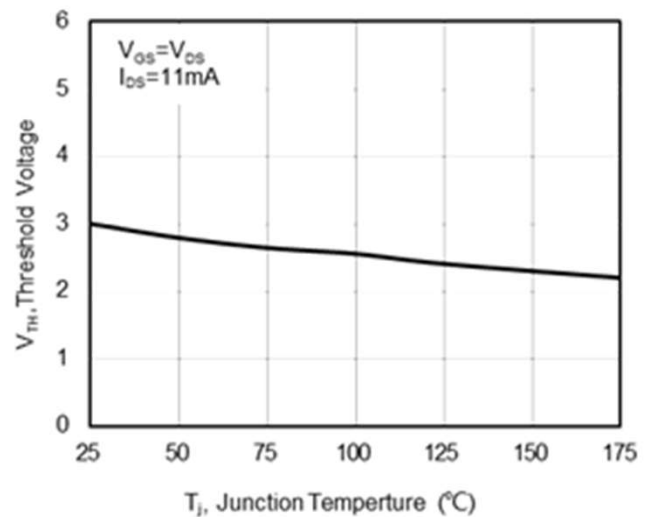


Fig 6. Gate Threshold vs Temperature

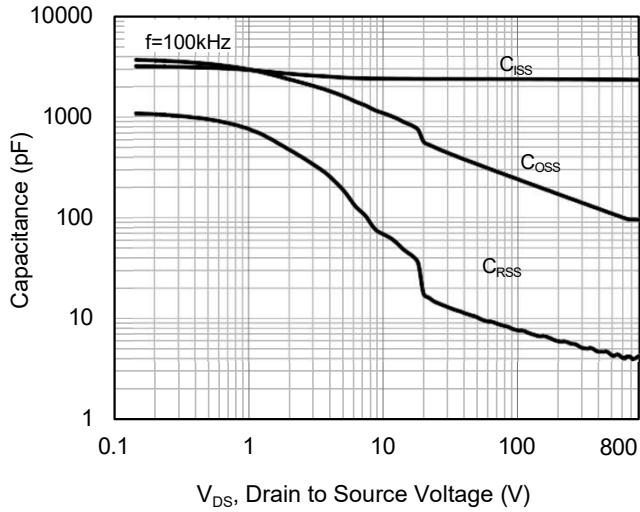


Fig 7. Capacitance Characteristics

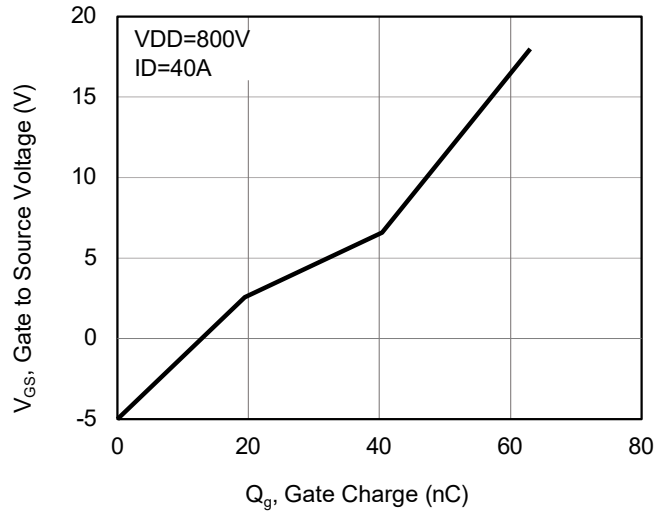


Fig 8. Gate Charge Characteristics

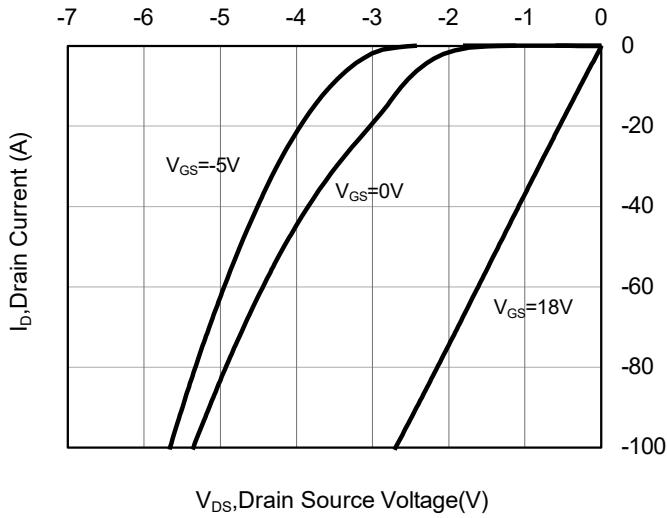


Fig 9. 3rd Quadrant Characteristic at  $25\text{ }^\circ\text{C}$

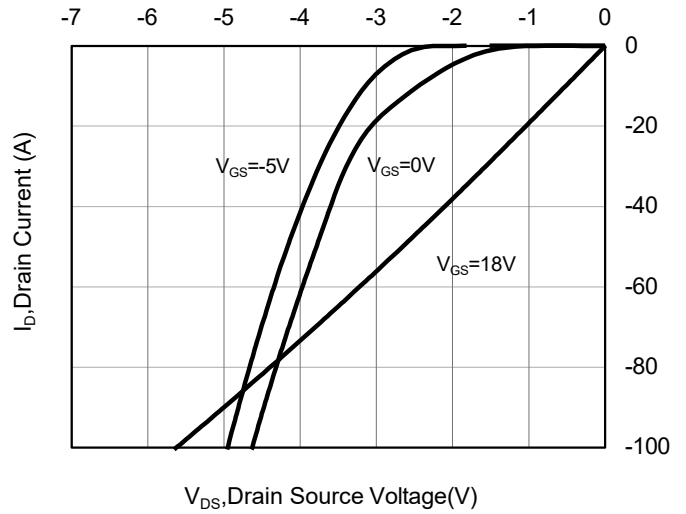
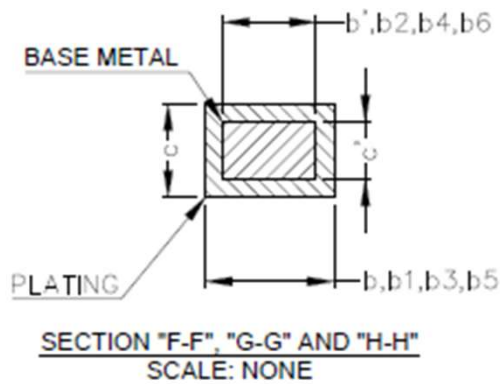
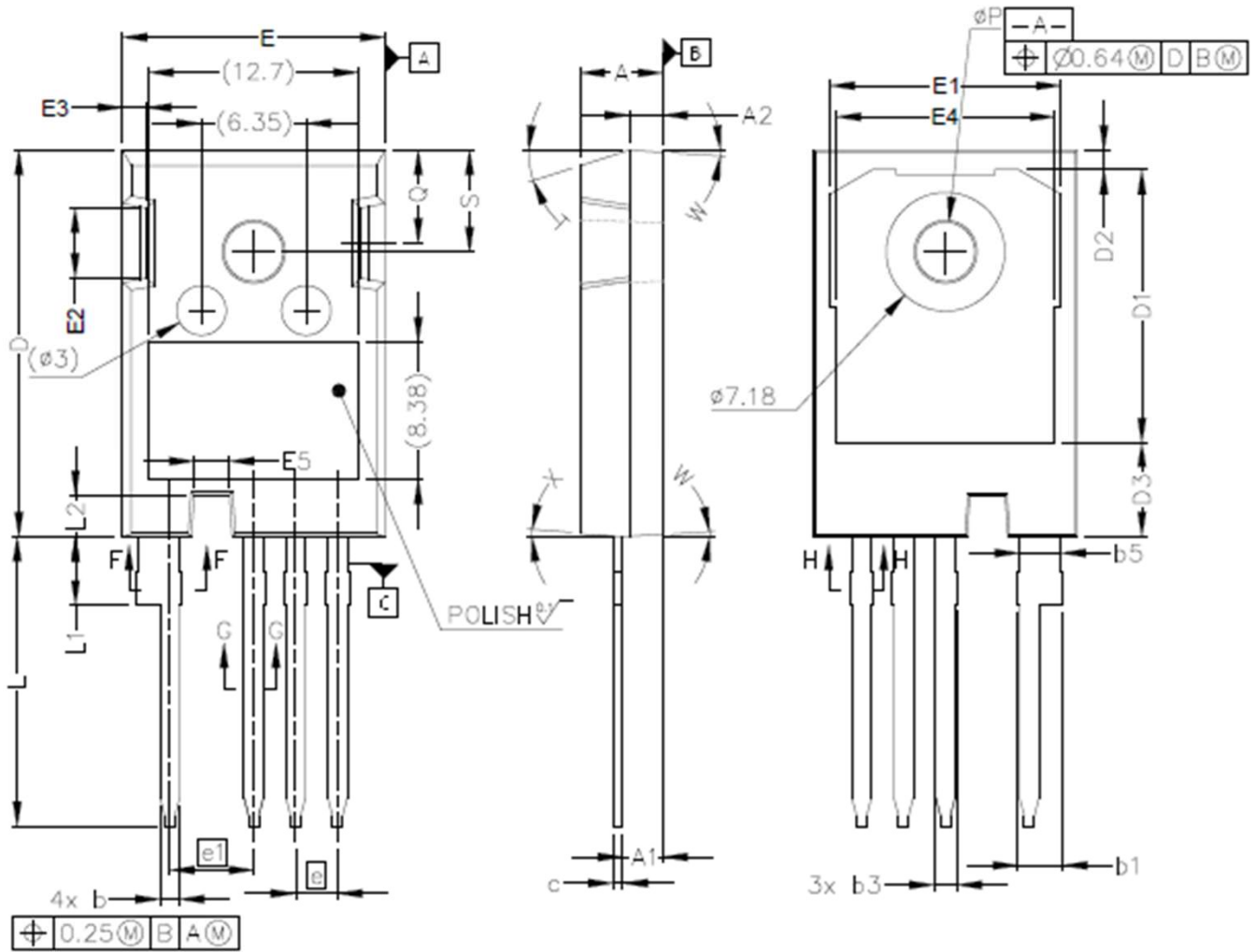


Fig 10. 3rd Quadrant Characteristic at  $175\text{ }^\circ\text{C}$

Package Outline: TO-247-4L



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**NOTE :**

1. ALL METAL SURFACES: TIN PLATED EXCEPT AREA OF CUT
2. DIMENSIONING & TOLERANCING CONFIRM TO ASME Y14.5M-1994.
3. ALL DIMENSIONS ARE IN MILLIMETERS.  
ANGLES ARE IN DEGREES.

SYMBOL	MILLIMETERS	
	MIN	MAX
A	4.83	5.21
A1	2.29	2.54
A2	1.91	2.16
b'	1.07	1.28
b	1.07	1.33
b1	2.39	2.94
b2	2.39	2.84
b3	1.07	1.60
b4	1.07	1.50
b5	2.39	2.69
b6	2.39	2.64
c'	0.55	0.65
c	0.55	0.68
D	23.30	23.60
D1	16.25	17.65
D2	0.95	1.25
D3	5.55	6.15
E	15.75	16.13
E1	13.10	14.15
E2	3.68	5.10
E3	1.00	1.90
E4	12.38	13.43
E5	1.95	2.35
e	2.54 BSC	
e1	5.08 BSC	
N	4	
L	17.31	17.82
L1	3.97	4.37
L2	2.35	2.65
øP	3.51	3.65
Q	5.49	6.00
S	6.04	6.30
T	17.5° REF.	
W	3.5° REF.	
X	4° REF.	

## Marking Information

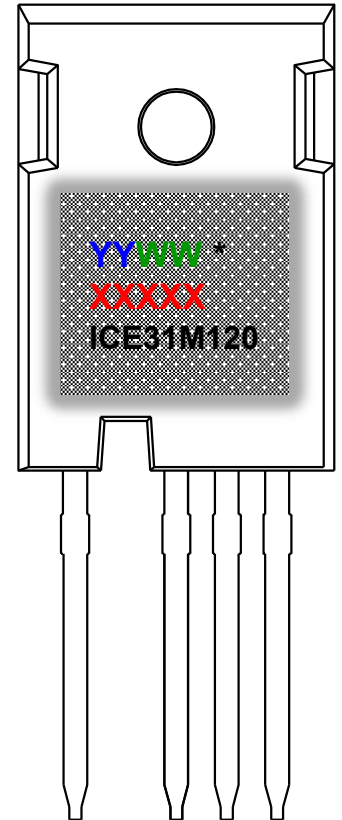
**YY** = Last two digits of the year

**WW** = Work week

**\*** = Site ID

**XXXXX** = Lot ID

**ICE31M120** = ICE is IceMOS logo and  
31M120 is a designated device part  
number



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